

A New Generation Nb₃Sn wire, and the Prospects for its Use in Particle Accelerators

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WAMS 2004

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Thanks to the following contributors:

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 - E. W. Collings (OSU)
 - L. Cooley (BNL)
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 - P. Lee (UW-M)
 - P. McIntyre (TAMU)
 - B. Strauss (DOE)
 - P. Wanderer (BNL)
 - A. Zlobin (FNAL)

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Superconducting Magnet Program

OST

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- OKAS
- SBIR Program Participants
- W.Wisc (P.Lee)



- Accelerator magnet applications for Nb₃Sn --LHC Luminosity Upgrade --LHC Energy Upgrade Conductor Development Program Status and Plans --Performance improvements (Jc and D_{eff}) --Cost reductions
 - --New conductors

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Possible LHC upgrades would require large quantities of Nb₃Sn wire

• 20 tons for the interaction region quadrupole upgrade (timeframe--2010)

• As much as 500 tons for an energy upgrade to 14 TeV (timeframe--?)

• Conductor R&D and production scaleup are required to meet the performance and quantity requirements.

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Goals and Target Specifications have been developed in collaboration with the CDG

- Goal: Provide <u>cost-effective</u>, <u>high-performance</u> superconductor required for luminosity upgrades and for the next generation high-energy physics colliders.
- Target specifications for the HEP conductor include:
 - --Jc (noncopper,12T,4.2 K): 3000 A/mm² (1500 @ 15 T)
 - --Effective filament size:
 - --Piece length:
 - --Heat treatment times:

--Wire cost:

Greater than 10,000 m in wire diam. of 0.3-1.0 mm

40 microns or less

Less than 200 hr; target is 50 hr for wind and react

Less than \$1.50/kA-m (12 T,4.2 K)

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Steps toward improvements in Jc

- Optimize use of available space

 -OST and OKAS focus during first 2 years R&D
 -a Jc increase from 2000 to 3000 A/mm² (12 T,
 4.2 K) has been achieved
- 2. Optimize heat treatment

--high Nb, Sn composites require different heat treatments (OST-MJR Jc increased from 2600 to 2900 A/mm²)

--Lab/Univ support includes microstructure evolution studies and improved Ic testing

3. Refine grain size in Nb₃Sn

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OST has achieved world record Jc values for Nb₃Sn made by two processes (LTSW Nov'02)



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 \bullet J_c performance as good or better than MJR

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- Much better piece length than MJR
- Use of rods and extrusion instead of sheets and all-cold drawing makes yield more predictable
- J_c (12 T, 4.2) ~3000 A/mm² (one short sample over 3000 A/mm² at OST)





OST RRP Wire--HT and Test at LBNL

- OST B6555, 49%Cu
- HT 650 C, 200hr
- RRR=15

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- $D_{eff} \sim 100 \ \mu m$
- Stable to 58 $\mu V/m$



Current [A]

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PAC'03 Portland, OR, May 2003 Superconducting Magnet Program



OST Nb₃Sn wire #6581 (higher Nb₃Sn %): Axial strain effect at 4 K & 16.5 T--data from Ekin and Cheggour, NIST





OST has completed production quantities of high Jc wires for use in Dipole HD-1

- MJR process (50 kg delivered Aug 2002, meets specification)
 --Jc (12T, 4.2K) > 2250 A/mm²
 - --RRR(copper residual resistivity ratio) > 2
 - --Yield: > 72 % piece lengths > 250 m
 - --D_{eff} < 100 microns
- RRP process (50 kg delivered Jan 2003, exceeds Jc spec.)
 -Jc > 2750 A/mm²; best value > 3000 A/mm²
 - --RRR > 15
 - --Yield: 86 % piece lengths > 250 m
 - $-D_{eff} < 100$ microns

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Comparison of low, moderate and high Jc subelements

•Low--filaments are discreet and not interconnected; diffusion barrier is Ta

•Moderate--Filaments are discreet, but interconnected, diffusion barrier is Ta or Nb

•High--filaments have coalesced to form a monolithic structure, diffusion barrier is Nb



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Magnetization loop for high Jc wire shows evidence for partial flux jumps

Magnetization per Total Sample Volume



OST wire with distributed barrier; Jc=3000 A/mm2, D_{eff}=80 microns

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Limits to increasing Jc by increasing Nb and Sn volume fractions

- Large magnetization
- Flux jump instabilities
- Lower matrix RRR
- Fabrication issues
- Filament dissolution during reaction step



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Increase number of subelements (OST, Supergenics SBIRs)

• Use fins to subdivide subelements (OKAS, Supergenics, OST)

• PIT conductor fabrication (Shape Metal Industries, Supercon)

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More Sub-Elements Required . . or

- Large number of sub-elements needed – with associated stacking problems – unless the subelements are sub-divided
- Even so, > 36 subelements required

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From P. Lee, PAC'03





Key task for reduced D_{eff} is to determine methods (and limits) for restacks

Subelement restack issues include:

- --Single or double restack
- --Bonding
- --Subelement/barrier distortion
- --Matching hardness of components
- --Sn rod size for HER



OKAS restack with 54 subelements, 3 fins

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- Demonstrate HER process for making high J_c, low D_{eff} wire
- Distributed barrier design (highest J_c,good D_{eff})
 --127 subelements
 --D_{eff} = 40 µm, 0.6 mm diam.



 Cost reduction/improved piece lengths Hot extruded rod with 18 holes, ready for loading Sn rods

Improved RRR

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OKAS R&D Program

• Fabricate reduced D_{eff} wire using fins

• Improve drawability of the OKAS internal tin wire

(scaleup work for ITER--will benefit HEP as well)

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A New Approach for reducing Deff without increasing number of subelements: fins

- SBIR work by Supergenics/OKAS
 - --radial fins to prevent filaments from coalescing
 - --short barrier section to prevent reaction on Nb barrier
 - --add more fins to further subdivide Nb₃Sn
 - --penalty is only 0.4-0.8 % area fraction per fin
 - --Ta 40 wt% Nb alloy



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Fin approach is continuing at both Supergenics and OKAS

- OKAS
 - --three radial fins
 - --Ta 40 wt % Nb alloy
 - --add more fins to further subdivide Nb₃Sn --use as subelement for restack
- Should be applicable to many fabrication processes



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Features of Fin Reaction – Electron Backscatter--data from P.Lee



Cost/performance improvements for HEP and Fusion-type Nb₃Sn wires



Further improvements must come from process scale-up. New ITER?

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Conductor Costs for High Field Accelerator Magnets (12T, 4.2K)

• Nb_3Sn (OST RRP)--\$5.75/kA-m

• Nb₃Sn (MJR)--\$7.74/kA-m

• Nb₃Sn (PIT)--\$28.94/kA-m

• Bi-2212 (PIT)--\$57.00/kA-m These prices are for small, custom-processed orders

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U.S. DOE funding for conductor R&D

- \$500 K/year for HEP base program (starting in 2000 and continuing in FY05)
 - -Nb₃Sn R&D at OST and OKAS
- \$2000K--2500K/year for HEP and OFE SBIR program
 - -Nb₃Sn R&D at Supercon, Supergenics, Hypertech, Accelerator Technology Corp, Innovare, Superconducting Systems, Alabama Cryogenic
 - -Nb3Al R&D at Hypertech, Global R&D, Innovare -Insulation R&D at CTD and MCT

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Cost reduction tasks for HEP R&D program include

- Billet scale-up
 -- OST HER
 - -- OKAS restack rod
- Improved raw materials

 Replacement for Sn-Ti alloy
 Ductile diffusion barriers

-Note: We rely on the ITER program to provide the large volume production capability for Nb₃Sn

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Bi-2212 round wire shows promise for accelerator magnets

- Jc(12T, 4.2K, non-silver) > 2000 A/mm² in new material (Showa, OST)
- Long lengths(> 1500 m) are being produced
- New result: 30 strand cable; Ic = 6.8 kA at 6 T
- React/wind (BNL) and Wind/react (LBNL) coils will be evaluated



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Comparison of Je for Nb₃Sn and Bi-2212



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Steady progress continues toward program coals

- Long Range Goals
- $Jc = 3000 \text{ A/mm}^2$
- $D_{eff} = 40$ microns or less
- Piece length > 10,000 m
- Heat treatment < 400 hr

- <u>Progress</u>
- $Jc = 3000 \text{ A/mm}^2 \text{ (FY03)}$
- Proof of principle shown; practical demos in progress
- 250-1500m for both MJR and RRP internal Sn processes
- 150 hr

• Cost: < \$1.50/kA-m(12 T)

• \$ 5.50/kA-m (RRP)

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